



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kevin M. McHugh

Serial No.: 09/592,003

Filed: June 12, 2000

For: RAPID SOLIDIFICATION
PROCESSING FOR PRODUCING MOLDS,
DIES AND RELATED TOOLINGS

Examiner: Leyson

Group Art Unit: 1722

Attorney Docket No.: EGG-PI-612A1a

RECEIVED
APR 23 2003
TC 1700

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

4/14/03
Date of Deposit

14C/KD
4/24/03
Signature of registered practitioner or other person having reasonable basis to expect mailing to occur on date of deposit shown pursuant to 37 C.F.R. § 1.8(a)(1)(ii)

Mandy Landon
Typed/printed name of person whose signature is contained above

PRELIMINARY AMENDMENT

The Commissioner of Patents and Trademarks
Washington, D.C. 20231

Sir:

Prior to examination of the above-referenced patent application on the merits, please
amend the application as follows: